

## April 2026 Billings (Express Report)

### Japan-based Semiconductor Manufacturing Equipment

Note : All data is based on three month average numbers.

Mark your calendars. [The May Report SEAJ's Web site update](#) is scheduled on **19th June** approximately 3:40P.M.Japan Time. Up dates are subject to change.

#### Japanese Semiconductor Equipment Industry Posts **April 2026 Billings of ¥510,155 million**

Tokyo Japan, **May 25th, 2026** JAPAN-based manufacturers of semiconductor equipment posted **¥510,155 million** in billings in **April 2026**(three-month average basis) published today by SEAJ.

The billings figure is **6.2 percent up** the final **March 2026** level of **¥480,182 million** and **14.1 percent up** the **2025 April** billings level of **¥447,038 million**.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Month-Over-Month	Year-Over-Year
November 2025	420,670	1.6%	3.7%
December 2025	423,487	0.7%	-4.5%
January 2026	427,508	0.9%	2.6%
February 2026	423,103	-1.0%	2.7%
March 2026(final)	480,182	13.5%	11.1%
April 2026(prim)	510,155	6.2%	14.1%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

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